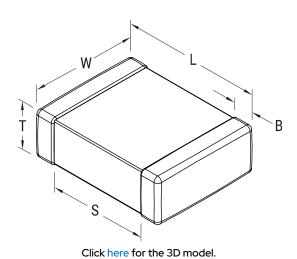


C1210X123MATACTU

Aliases (C1210X123MATAC7800)

SMD Comm X8G HT150C Flex, Ceramic, 0.012 uF, 20%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 1210, 1.5 mm



General Information	
Series	SMD Comm X8G HT150C Flex
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	30 mg
Shelf Life	78 Weeks
MSL	1

0.012 uF

Time is 1000 Hours

83.3333 GOhms

Dimensions	
Chip Size	1210
L	3.3mm +/-0.4mm
W	2.6mm +/-0.3mm
Т	0.78mm +/-0.20mm
S	1.5mm MIN
В	0.6mm +/-0.25mm

3.3mm +/-0.4mm	Measurement Condition	1 kHz 1.0Vrms
2.6mm +/-0.3mm	Tolerance	20%
0.78mm +/-0.20mm	Voltage DC	250 VDC
1.5mm MIN	Dielectric Withstanding Voltage	625 VDC
0.6mm +/-0.25mm	Temperature Range	-55/+150°C
	Temp. Coefficient	X8G
	Capacitance Change with Reference to +25°C and 0 VDC	30 ppm/C, 1kHz 1.0Vrms
T&R, 180mm, Plastic Tape	Applied (TCC)	
4000	Dissipation Factor	0.1% 1 kHz 1.0Vrms
	Aging Rate	0% Loss/Decade Hour: Referee

Insulation Resistance

Specifications

Capacitance

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	4000

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